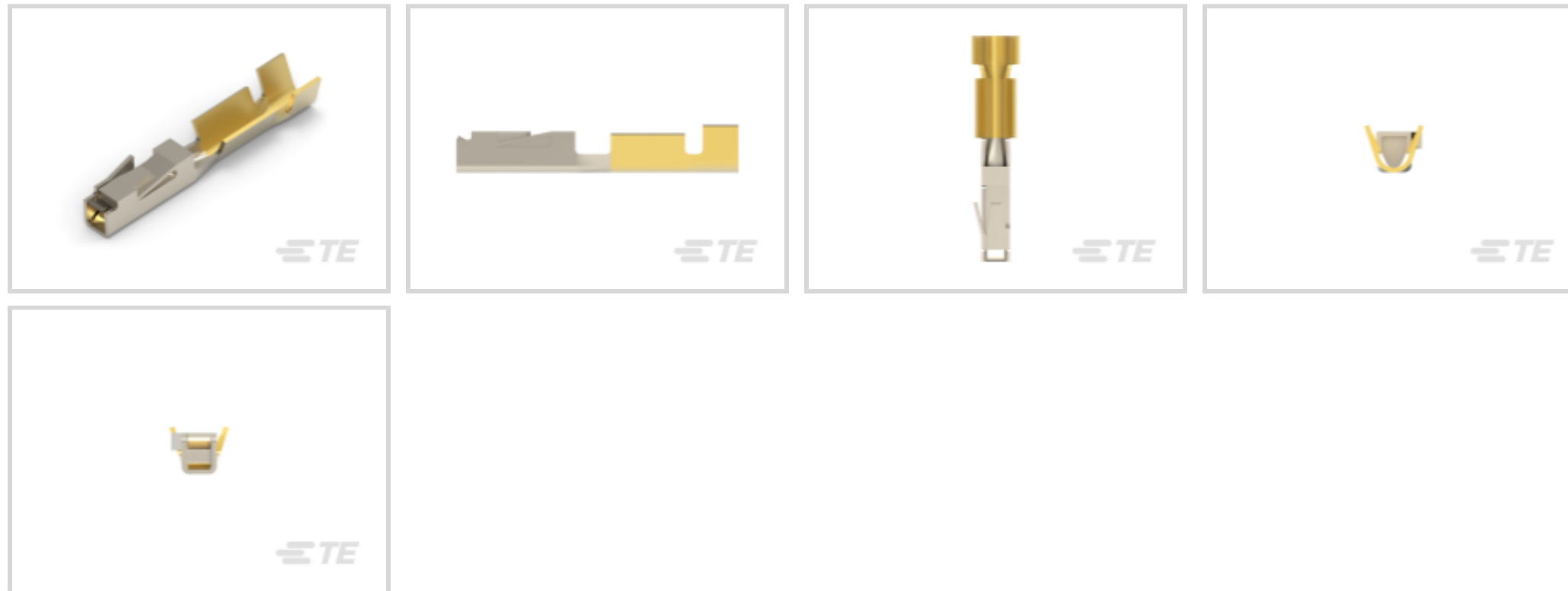




Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Connector Contacts



Contact Type: **Socket**

Contact Mating Area Plating Material: **Gold**

Wire Size: **.21 – .51 mm²**

Contact Orientation: **Straight**

Features

Product Type Features

Applied Pressure	Standard
Connector & Contact Terminates To	Wire & Cable

Contact Features

Contact Mating Area Plating Material Thickness	.8 μm
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Type	Socket
Contact Mating Area Plating Material	Gold
Contact Orientation	Straight
Contact Current Rating (Max)	3 A

Termination Features

Termination Method to Wire & Cable	Crimp
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Mechanical Attachment

Wire Insulation Support	With
PCB Mount Retention	Without



Dimensions

Compatible Insulation Diameter Range	.91 – 1.37 mm [.035 – .054 in]
Wire Size	.21 – .51 mm ²

Usage Conditions

Operating Temperature Range	-65 – 105 °C [-85 – 221 °F]
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Operation/Application

Circuit Application	Power & Signal
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Packaging Features

Packaging Quantity	200
Packaging Method	Loose Piece

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Customers Also Bought



Documents



Product Drawings

TANDEM SPR.REC.F

English

CAD Files

Customer View Model

ENG_CVM_166722-1_Z.3d_igs.zip

English

Customer View Model

ENG_CVM_166722-1_Z.3d_stp.zip

English

Customer View Model

ENG_CVM_166722-1_Z.2d_dxf.zip

English

3D PDF

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_166722-1_Z.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_166722-1_Z.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_166722-1_Z.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Product Specification

English

Product Specification

English

Product Environmental Compliance

TANDEM SPR.REC.F

English

TANDEM SPR.REC.F

English